

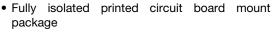
IGBT SIP Module (Ultrafast IGBT)



IMS-2

PRODUCT SUMMARY						
OUTPUT CURRENT IN A TYPICAL 20 kHz MOTOR DRIVE						
V _{CES}	600 V					
I _{RMS} per phase (3.5 kW total) with T _C = 90 °C	12 A _{RMS}					
TJ	125 °C					
Supply voltage	360 V _{DC}					
Power factor	0.8					
Modulation depth (see fig. 1)	115 %					
V _{CE(on)} (typical) at I _C = 10 A, 25 °C	1.56 V					
Speed	8 kHz to 30 kHz					
Package	SIP					
Circuit	Three phase inverter					

FEATURES





• Switching-loss rating includes all "tail" losses

- HEXFRED® soft ultrafast diodes
- · Optimized for high speed, see fig. 1 for current vs. frequency curve
- UL approved file E78996
- · Designed and qualified for industrial level
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The IGBT technology is the key to Vishay's Semiconductors advanced line of IMS (Insulated Metal Substrate) power modules. These modules are more efficient than comparable bipolar transistor modules, while at the same time having the simpler gate-drive requirements of the familiar power MOSFET. This superior technology has now been coupled to a state of the art materials system that maximizes power throughput with low thermal resistance. This package is highly suited to motor drive applications and where space is at a premium.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
0 .:		T _C = 25 °C	20		
Continuous collector current, each IGBT	I _C	T _C = 100 °C	10		
Pulsed collector current	I _{CM} ⁽¹⁾		60		
Clamped inductive load current	I _{LM} (2)		60	A	
Diode continuous forward current	I _F	T _C = 100 °C	9.3		
Diode maximum forward current	I _{FM}		60		
Gate to emitter voltage	V_{GE}		± 20	V	
Isolation voltage	V _{ISOL}	t = 1 min, any terminal to case	2500	V _{RMS}	
Maximum power dissipation, each IGBT	P _D	T _C = 25 °C	63	w	
		T _C = 100 °C	25	vv	
Operating junction and storage temperature range	T _J , T _{Stg}		-40 to +150	°C	
Soldering temperature		For 10 s, (0.063" (1.6 mm) from case)	300		
Mounting torque		6-32 or M3 screw	5 to 7 (0.55 to 0.8)	lbf ⋅ in (N ⋅ m)	

⁽¹⁾ Repetitive rating; $V_{GE} = 20 \text{ V}$, pulse width limited by maximum junction temperature (see fig. 20)

 $^{^{(2)}}$ V_{CC} = 80 % (V_{CES}), V_{GE} = 20 V, L = 10 μ H, R_G = 10 Ω (see fig. 19)





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THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TYP.	MAX.	UNITS	
Junction to case, each IGBT, one IGBT in conduction	R _{thJC} (IGBT)	-	2.0		
Junction to case, each DIODE, one DIODE in conduction	R _{thJC} (DIODE)	-	3.0	°C/W	
Case to sink, flat, greased surface	R _{thCS} (MODULE)	0.10	-		
Weight of module		20	i	g	
Weight of module		0.7	i	OZ.	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES} (1)	$V_{GE} = 0 \text{ V}, I_{C} = 25$	i0 μA	600		-	V
Temperature coefficient of breakdown voltage	$\Delta V_{(BR)CES}/\Delta T_J$	V _{GE} = 0 V, I _C = 1.0 mA		-	0.63	-	V/°C
	V _{CE(on)}	I _C = 10 A	V _{GE} = 15 V See fig. 2, 5	-	1.56	2.1	V
Collector to emitter saturation voltage		I _C = 20 A		-	1.84	-	
Concessor to entitler saturation voltage		I _C = 10 A, T _J = 150 °C		-	1.56	-	
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$		3.0	-	6.0	
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)}/\Delta T_{J}$	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$		-	- 13	-	mV/°C
Forward transconductance	g _{fe} ⁽²⁾	V _{CE} = 100 V, I _C = 10 A		11	18	-	S
Zero gate voltage collector current	Ices	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$		-	-	250	
		V _{GE} = 0 V, V _{CE} = 600 V, T _J = 150 °C		-	-	3500	μΑ
Diode forward voltage drop	V _{FM}	I _C = 15 A	See fig. 13	-	1.3	1.7	V
		I _C = 15 A, T _J = 150 °C		-	1.2	1.6	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V		-	-	± 100	nA

Notes

 $^{(1)}~$ Pulse width $\leq 80~\mu s,~duty~factor \leq 0.1~\%$

⁽²⁾ Pulse width 5.0 µs; single shot





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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Q_g	I _C = 10 A	I _C = 10 A		-	100	160	nC
Gate to emitter charge (turn-on)	Q _{ge}	$V_{CC} = 400 \text{ V}$			-	16	24	
Gate to collector charge (turn-on)	Q _{gc}	V _{GE} = 15 V See fig. 8			-	40	55	
Turn-on delay time	t _{d(on)}	<u> </u>			-	41	-	
Rise time	t _r	T _J = 25 °C	T. – 25 °C		-	13	-	1
Turn-off delay time	t _{d(off)}	$I_{\rm C} = 10 \text{ A}, V_{\rm C}$			-	96	140	ns
Fall time	t _f	$V_{GE} = 15 \text{ V}, R_G = 10 \Omega$ Energy losses include "tail" and diode				110	160	1
Turn-on switching loss	E _{on}	reverse recovery See fig. 9, 10, 11, 18			-	0.26	-	
Turn-off switching loss	E _{off}				-	0.18	-	mJ
Total switching loss	E _{ts}					0.44	0.7	
Turn-on delay time	t _{d(on)}	T _{.1} = 150 °C				39	-	
Rise time	t _r	$I_{C}=10$ A, $V_{CC}=480$ V $V_{GE}=15$ V, $R_{G}=10$ Ω Energy losses include "tail" and diode reverse recovery			-	15	-	ns
Turn-off delay time	t _{d(off)}				-	220	-	
Fall time	t _f				-	160	-	
Total switching loss	E _{ts}	See fig. 9, 10, 11, 18		-	0.74	-	mJ	
Input capacitance	C _{ies}	$V_{GE} = 0 \text{ V}$ $V_{CC} = 30 \text{ V}$ $f = 1.0 \text{ MHz}$		-	2100	-		
Output capacitance	C _{oes}			-	110	-	рF	
Reverse transfer capacitance	C _{res}	See fig. 7	,		-	34	-	
Divide the second of the secon		T _J = 25 °C	0544	-	42	60		
Diode reverse recovery time	t _{rr}	T _J = 125 °C	See fig. 14		-	74	120	ns
Diada paak rayawa raasyaw aharra	,	T _J = 25 °C	See fig. 15 I _F = 15 A V _B = 200 V		-	4.0	6.0	Α
Diode peak reverse recovery charge	I _{rr}	T _J = 125 °C			-	6.5	10	_ ^
Diode reverse recovery charge	0	T _J = 25 °C	See fig. 16	V _R = 200 V dI/dt = 200 A/μs	-	80	180	nC
	Q _{rr}	T _J = 125 °C			-	220	600	IIC
Diode peak rate of fall of	dl/d+	T _J = 25 °C See fig. 17		-	188	-	A/µs	
	T _J = 125 °C	See lig. 17	See lig. 17	-	160	-	ΑνμS	

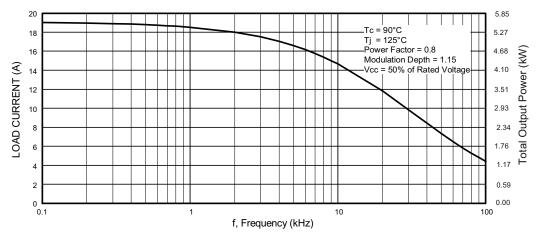


Fig. 1 - Typical Load Current vs. Frequency (Load Current = I_{RMS} of Fundamental)

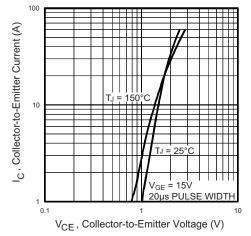


Fig. 2 - Typical Output Characteristics

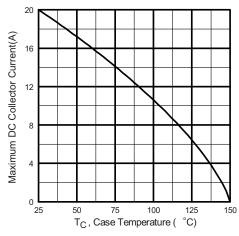


Fig. 4 - Maximum Collector Current vs. Case Temperature

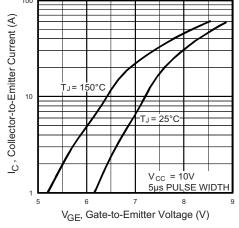


Fig. 3 - Typical Transfer Characteristics

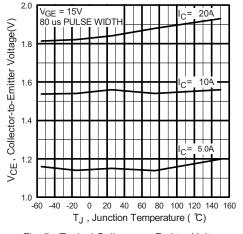


Fig. 5 - Typical Collector to Emitter Voltage vs. Junction Temperature



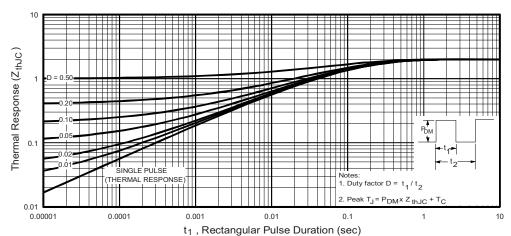


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case

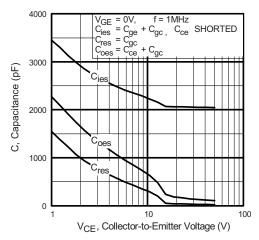


Fig. 7 - Typical Capacitance vs. Collector to Emitter Voltage

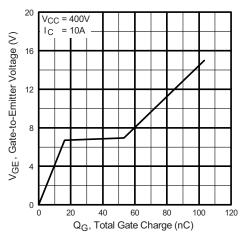


Fig. 8 - Typical Gate Charge vs. Gate to Emitter Voltage

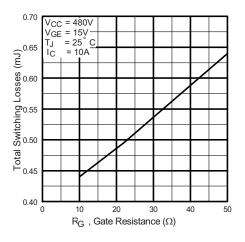


Fig. 9 - Typical Switching Losses vs. Gate Resistance

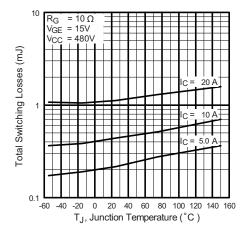


Fig. 10 - Typical Switching Losses vs. Junction Temperature

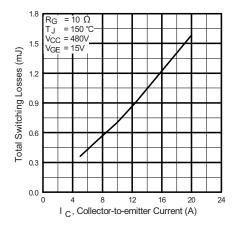


Fig. 11 - Typical Switching Losses vs. Collector to Emitter Current

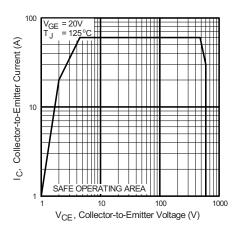


Fig. 12 - Turn-Off SOA

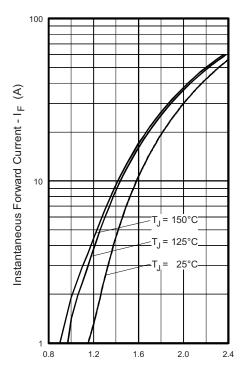


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

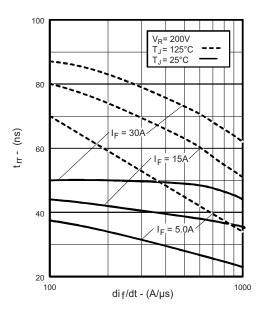


Fig. 14 - Typical Reverse Recovery Time vs. dl_F/dt

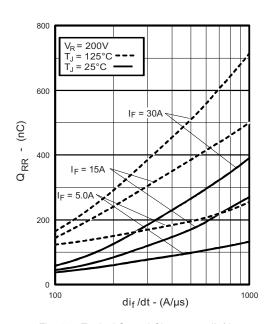


Fig. 16 - Typical Stored Charge vs. dl_F/dt

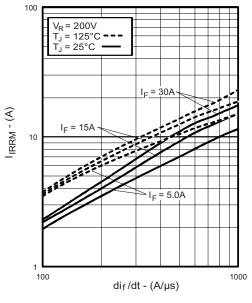


Fig. 15 - Typical Recovery Current vs. dI_F/dt

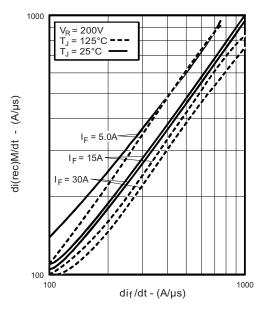


Fig. 17 - Typical $dI_{(rec)M}/dt$ vs dI_F/dt

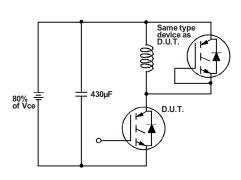


Fig. 18 - Test Circuit for Measurement of I_{LM} , E_{on} , $E_{off(diode)}$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

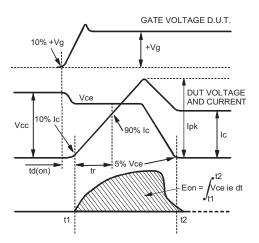


Fig. 20 - Test Waveforms for Circuit of Fig. 18a, Defining E_{on} , $t_{d(on)}$, t_r

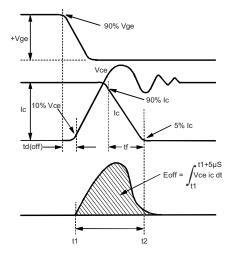


Fig. 19 - Test Waveforms for Circuit of Fig. 18a, Defining $E_{\rm off},\,t_{\rm d(off)},\,t_{\rm f}$

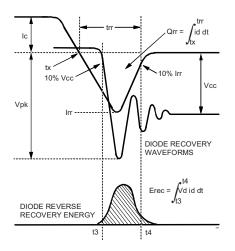


Fig. 21 - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

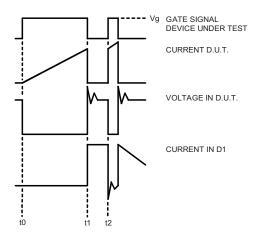
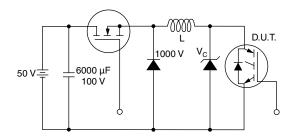


Fig. 18e - Macro Waveforms for Figure 18a's Test Circuit





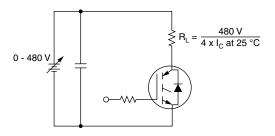
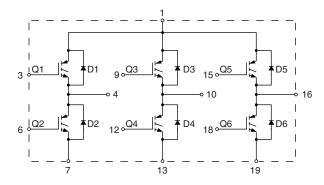


Fig. 19 - Clamped Inductive Load Test Circuit

Fig. 20 - Pulsed Collector Current Test Circuit

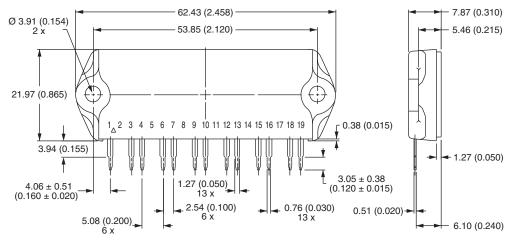
CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95066			

IMS-2 (SIP)

DIMENSIONS in millimeters (inches)



IMS-2 Package Outline (13 Pins)

Notes

- $^{(1)}$ Tolerance uless otherwise specified \pm 0.254 mm (0.010")
- (2) Controlling dimension: inch
- (3) Terminal numbers are shown for reference only

Document Number: 95066 Revision: 30-Jul-07

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